PAN	ĴΪΤ
	SEMI CONDUCTOR

Unit: inch(mm)

0.018(0.45)

0.010(0.25)

0.040(1.00)

S2

4

3

D2

2

G1

1

S1

0.044(1. MAX.

PJT7603 Complementary Enhancement Mode MOSFET – ESD Protected SOT-363 0.4A/-0.25A Voltage 50 / -60V Current 0.087(2.20) 0.030(0.75) Features 0.010(0.25) Advanced Trench Process Technology Specially Designed for Switch Load, PWM Application, etc. • 0.054(1.35) ESD Protected 2KV HBM Lead free in compliance with EU RoHS 2011/65/EU 0.056(1.40) 0.047(1.20) directive • Green molding compound as per IEC61249 Std. (Halogen Free) 0.004(0.10) 0.000(0.00) 0.012(0.30) 0.005(0.15) **Mechanical Data** D1 G2 5 6 Case: SOT-363 Package Terminals: Solderable per MIL-STD-750, Method 2026 • Approx. Weight: 0.0002 ounces, 0.006 grams •

• Marking: T63

Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	N-Ch LIMIT	P-Ch LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	50	-60	V
Gate-Source Voltage	V_{GS}	<u>+</u> 20	<u>+</u> 20	V	
Continuous Drain Current	I _D	400	-250	mA	
Pulsed Drain Current (Note 4)	I _{DM}	1200	-900	mA	
	T _a =25°C		350		mW
Power Dissipation	Derate above 25°C	P _D	2.8		mW/°C
Operating Junction and Storage Ter	T_J, T_{STG}	-55~150		°C	
Typical Thermal resistance - Junction to Ambient ^(Note 3)		R _{eJA}	357		°C/W



N-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static	OTMOOL				III <i>F</i> UA.	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D = 250uA	50	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}= 250 \text{uA}$	0.5	0.9	1.0	V
Drain-Source On-State Resistance		V _{GS} = 10V, I _D = 500mA	-	1.2	1.5	_
	$R_{DS(on)}$	V _{GS} = 4.5V, I _D = 200mA	-	1.3	2.5	Ω
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 50V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V, V _{DS} =0V	-	-	<u>+</u> 10	uA
Dynamic (Note 5)		•				
Total Gate Charge	Qg	V _{DS} =25V, I _D =500mA, V _{GS} =4.5V	-	0.95	-	nC
Gate-Source Charge	Q_gs		-	0.34	-	
Gate-Drain Charge	Q_{gd}		-	0.32	-	
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V, f=1.0MHZ	-	36	-	pF
Output Capacitance	Coss		-	11	-	
Reverse Transfer Capacitance	Crss		-	6.6	-	
Turn-On Delay Time	td _(on)		-	2.3	-	
Turn-On Rise Time	tr	$V_{DD}=25V, I_{D}=500mA,$	-	20	-]
Turn-Off Delay Time	td _(off)	V_{GS} =10V, R _G =6 Ω ^(Note 1,2)	-	7	-	ns
Turn-Off Fall Time	tf		-	20	-	
Drain-Source Diode						
Maximum Continuous Drain-Source					400	
Diode Forward Current	I _S		-	-	400	mA
Diode Forward Voltage	V_{SD}	I _S = 500mA, V _{GS} =0V	-	0.9	1.5	V

NOTES :

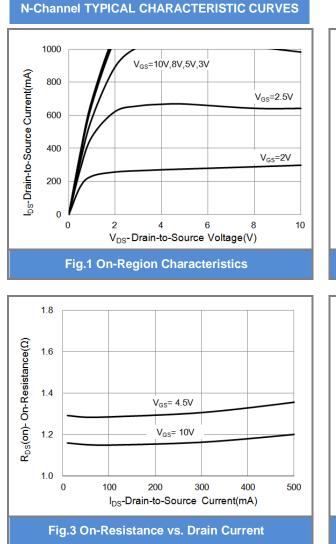
- 1. Pulse width</br>
- 2. Essentially independent of operating temperature typical characteristics.
- 3. RoJA is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.

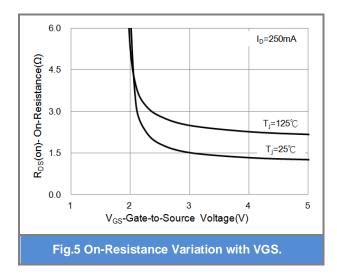


P-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =-250uA	-60	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250$ uA	-1.0	-1.5	-2.5	V
Drain-Source On-State Resistance		V _{GS} =-10V,I _D =-500mA	-	2.4	4	0
	$R_{DS(on)}$	V _{GS} =-4.5V,I _D =-200mA	-	2.7	6	Ω
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-48V,V _{GS} =0V	-	-	-1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V,V _{DS} =0V	-	-	<u>+</u> 100	nA
Dynamic (Note 5)						
Total Gate Charge	Qg	V _{DS} =-25V, I _D =-100mA, V _{GS} =-4.5V	-	1.1	-	nC
Gate-Source Charge	Q_gs		-	0.3	-	
Gate-Drain Charge	Q_gd		-	0.2	-	
Input Capacitance	Ciss	V _{DS} =-25V, V _{GS} =0V, f=1.0MHZ	-	51	-	pF
Output Capacitance	Coss		-	15	-	
Reverse Transfer Capacitance	Crss		-	2.2	-	
Turn-On Delay Time	td _(on)		-	4.8	-	
Turn-On Rise Time	tr	V_{DD} =-25V, I_{D} =-100mA,	-	19	-	
Turn-Off Delay Time	td _(off)	V_{GS} =-10V, R _G =6 Ω ^(Note 1,2)	-	52	-	ns
Turn-Off Fall Time	tf		-	32	-	
Drain-Source Diode						
Maximum Continuous Drain-Source					250	~^
Diode Forward Current	I _S		-	-	-250	mA
Diode Forward Voltage	V_{SD}	I _S =-500mA, V _{GS} =0V	-	-0.9	-1.5	V







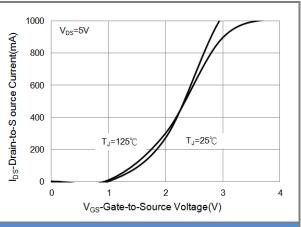


Fig.2 Transfer Characteristics

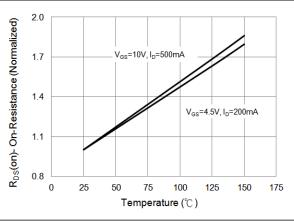
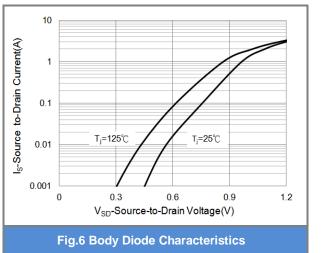


Fig.4 On-Resistance vs. Junction temperature





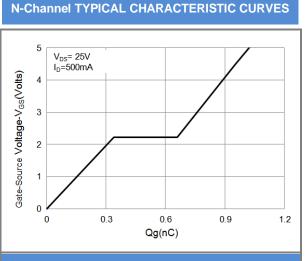


Fig.7 Gate-Charge Characteristics

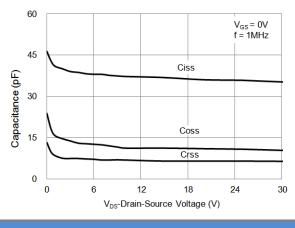
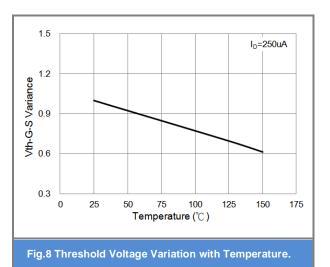
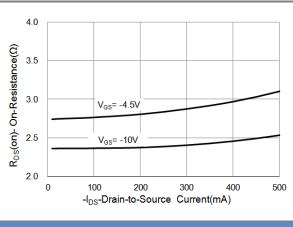


Fig.9 Capacitance vs. Drain-Source Voltage.

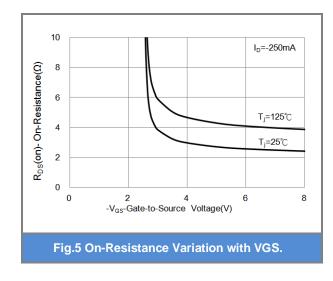


1000 V_{GS}=-10V, -6V, -5V,-4.5V -I_{DS}-Drain-to-Source Current(mA) 800 600 V_{GS}=-3V 400 V_{GS}=-2.5V 200 0 0 2 3 4 5 -V_{DS}- Drain-to-Source Voltage(V) **Fig.1 On-Region Characteristics**

P-Channel TYPICAL CHARACTERISTIC CURVES







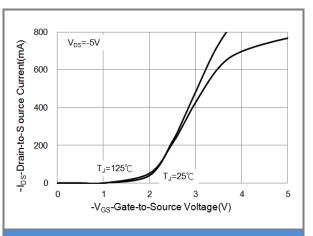


Fig.2 Transfer Characteristics

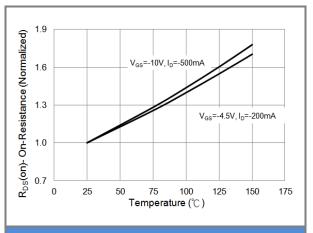
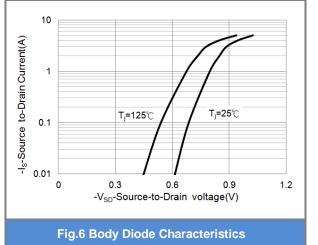
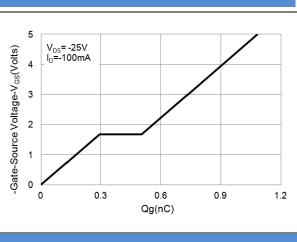


Fig.4 On-Resistance vs. Junction temperature







P-Channel TYPICAL CHARACTERISTIC CURVES

Fig.7 Gate-Charge Characteristics

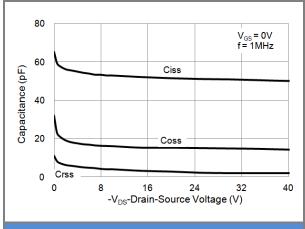
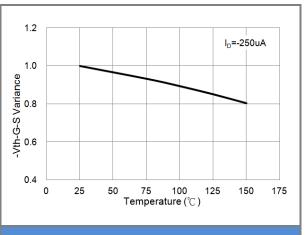


Fig.9 Threshold Voltage Variation with Temperature.



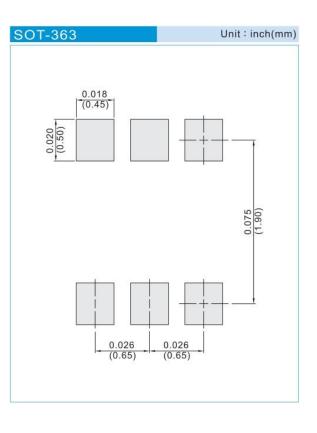




PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJT7603_R1_00001	SOT-363	3K pcs / 7" reel	T63	Halogen free
PJT7603_R2_00001	SOT-363	10K pcs / 13" reel	T63	Halogen free

MOUNTING PAD LAYOUT





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